

C0805X161KATACTU

Aliases (C0805X161KATAC7800) SMD Comm X8G HT150C Flex, Ceramic, 160 pF, 10%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.6 mm



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General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	11 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		s
Chip Size	0805	C
L	2mm +/-0.3mm	Ν
W	1.25mm +/-0.3mm	٦
т	0.78mm +/-0.20mm	١
S	0.6mm MIN	0
В	0.5mm +/-0.25mm	٦
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Packaging Specifications Packaging

Packaging Quantity

> T&R, 180mm, Plastic Tape 4000

Specifications	
Capacitance	160 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	10%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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